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|---|-----------------------------|----|-------------|--|--|
|   | Filing Date                 |    | 2005-07-27  |  |  |
|   | First Named Inventor Kurt F |    | Hess et al. |  |  |
|   | Art Unit                    |    | 2612        |  |  |
|   | Examiner Name Hung          |    | g T. Nguyen |  |  |
|   | Attorney Docket Number      | er | 2003P16170  |  |  |

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|   | 1  | 5495645                                 |                                | 1996-03         | -05                       | Suzuki et al.                 |  |        |                        |                            |    |
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|   | 1  | 1 166 246                               | EP                             |                 | A1                        | 2002-01-02                    | Nishikawa  |        |                        |                            |    |
|   | 2  | 2001-175963                             | JP                             |                 | А                         | 2001-06-29                    | Thuillard  |        | Correspond<br>Abstract | ing English                |    |

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| Examiner Name          | Hung T. Nguyen |                  |  |  |  |
| Attorney Docket Number |                | 2003P16170       |  |  |  |

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|   | 5          | 07-239988   | JP                  | A               | 1995-09-12      | Motohashi                 | Corresponding English<br>Abstract         |  |  |  |
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